

### FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,low forward voltage drop
- High surge capability
- High temperature soldering guaranteed:260°C/10 seconds at terminals
- Component in accordance to RoHS 2011/65/EU and WEEE 2012/19/EU



RoHS  
COMPLIANT



### MECHANICAL DATA

- Case: JEDEC SMB(DO-214AA) molded plastic body
- Terminals: Solder Plated, solderable per MIL-STD-750,method 2026
- Polarity: Color band denotes cathode end
- Weight: 0.003ounce, 0.093 gram

### TYPICAL APPLICATIONS

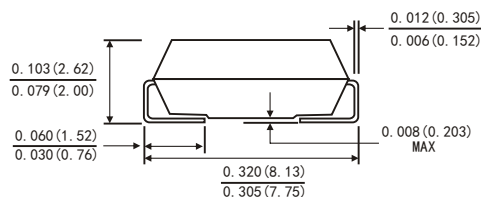
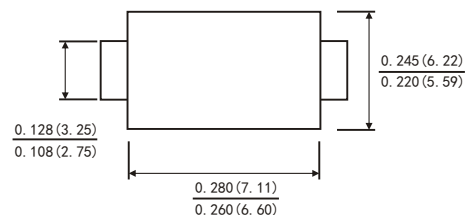
For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications

### MAXIMUM RATINGS

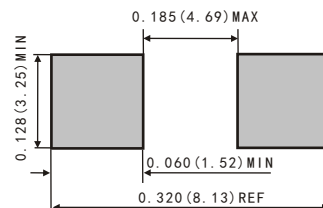
(Ratings at 25°C ambient temperature unless otherwise specified )

Parameter	Symbol	SS510LC	Unit
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	100	V
Maximum average forward rectified current (see fig.1)	I <sub>F(AV)</sub>	5.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I <sub>FSM</sub>	120	A
Operating junction temperature range	T <sub>J</sub>	-55 to+150	°C
Storage temperature range	T <sub>stg</sub>	-55 to+150	°C

### SMC(DO-214AB)



### Suggested PAD Layout



Dimensions in inches and (millimeters)

## RATINGS AND CHARACTERISTIC OF SS510LC

### ELECTRICAL CHARACTERISTICS (T<sub>A</sub>=25°C Unless otherwise noted)

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit
Instantaneous forward voltage	I <sub>F</sub> =5.0A	T <sub>A</sub> =25°C	V <sub>F</sub> <sup>1)</sup>	0.60	0.65	V
		T <sub>A</sub> =100°C		0.57	-	
		T <sub>A</sub> =125°C		0.55	-	
Reverse current	V <sub>R</sub> =100V	T <sub>A</sub> =25°C	I <sub>R</sub> <sup>2)</sup>	10	50	μA
		T <sub>A</sub> =100°C		1.7	5	mA
		T <sub>A</sub> =125°C		6	20	
Typical junction capacitance	4V, 1MHz		C <sub>J</sub>	370		pF

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle

2.Pulse test: pulse width≤40ms

### THERMAL CHARACTERISTICS (T<sub>A</sub>=25°C Unless otherwise noted)

Parameter	Symbol	SS510LC	Unit
Typical thermal resistance <sup>3)</sup>	R <sub>θJA</sub>	55.0	°C/W
	R <sub>θJL</sub>	17.0	

3. Unit mounted on PC board with 5.0mm×5.0mm (0.013mm thick) copper pads as heat sink

### AVAILABLE PACK INFORMATION

Product code	Pack	Reel Size (mm)	Quantity (pcs/reel)	Box Size L×W×H (mm)	Quantity (reel/box)	Carton Size L×W×H (mm)	Quantity (box/carton)
SS510LC-SMC	T/R	Φ300	3000	340×340×50	2	370×370×370	6

# RATINGS AND CHARACTERISTIC OF SS510LC

FIG.1-FORWARD CURRENT DERATING CURVE

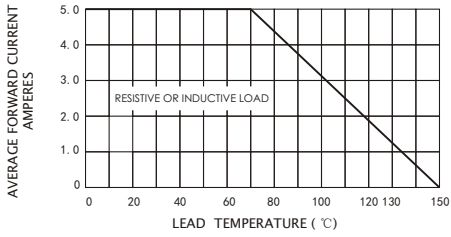


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

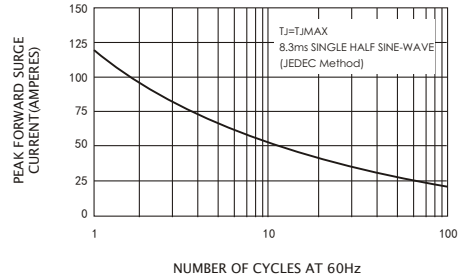


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

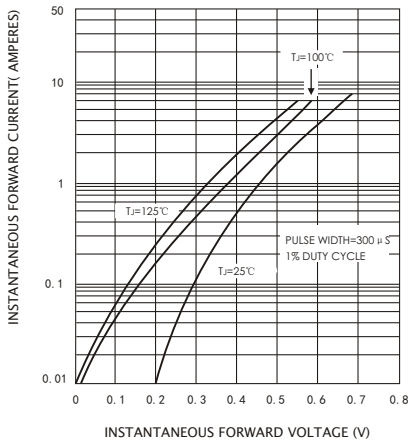


FIG.4-TYPICAL REVERSE CHARACTERISTICS

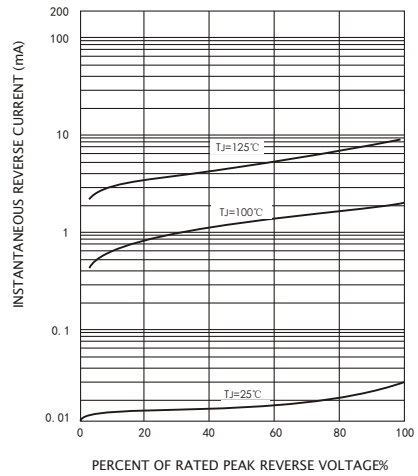


FIG.5-TYPICAL JUNCTION CAPACITANCE

